

1200V / 10A

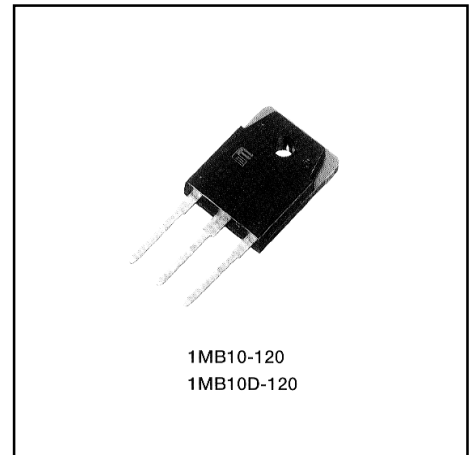
Molded Package

■ Features

- Small molded package
- Low power loss
- Soft switching with low switching surge and noise
- High reliability, high ruggedness (RBSOA, SCSOA etc.)
- Comprehensive line-up

■ Applications

- Inverter for Motor drive
- AC and DC Servo drive amplifier
- Uninterruptible power supply



■ Maximum ratings and characteristics

- Absolute maximum ratings (at $T_c=25^{\circ}\text{C}$ unless otherwise specified)

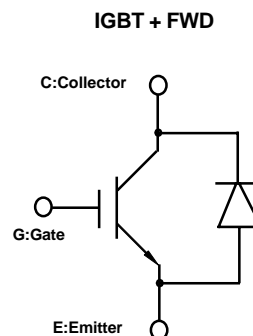
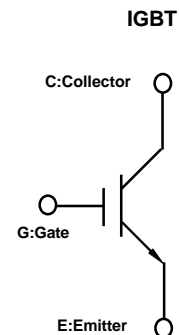
1MB10-120 / IGBT

Item	Symbol	Rating	Unit		
Collector-Emitter voltage	V_{CES}	1200	V		
Gate-Emitter voltage	V_{GES}	± 20	V		
Collector current	DC	$T_c=25^{\circ}\text{C}$	I_{c25}	16	A
		$T_c=100^{\circ}\text{C}$	I_{c100}	10	A
	1ms	$T_c=25^{\circ}\text{C}$	I_{cp}	48	A
Max. power dissipation(IGBT)	P_c	135	W		
Operating temperature	T_j	+150	$^{\circ}\text{C}$		
Storage temperature	T_{stg}	-40 to +150	$^{\circ}\text{C}$		
Screw torque	-	50	N-cm		

1MB10D-120 / IGBT+FWD

Item	Symbol	Rating	Unit		
Collector-Emitter voltage	V_{CES}	1200	V		
Gate-Emitter voltage	V_{GES}	± 20	V		
Collector current	DC	$T_c=25^{\circ}\text{C}$	I_{c25}	16	A
		$T_c=100^{\circ}\text{C}$	I_{c100}	10	A
	1ms	$T_c=25^{\circ}\text{C}$	I_{cp}	48	A
Max. power dissipation (IGBT)	P_c	135	W		
Max. power dissipation (FWD)	P_c	85	W		
Operating temperature	T_j	+150	$^{\circ}\text{C}$		
Storage temperature	T_{stg}	-40 to +150	$^{\circ}\text{C}$		
Screw torque	-	50	N-cm		

■ Equivalent Circuit Schematic



● Electrical characteristics (at Tj=25°C unless otherwise specified)

1MB10-120 / IGBT

Item	Symbol	Characteristics			Conditions	Unit
		Min.	Typ.	Max.		
Zero gate voltage collector current	ICES	–	–	1.0	VGE=0V, VCE=1200V	mA
Gate-Emitter leakage current	IGES	–	–	20	VCE=0V, VGE=±20V	µA
Gate-Emitter threshold voltage	VGE(th)	5.5	–	8.5	VCE=20V, IC=10mA	V
Collector-Emitter saturation voltage	VCE(sat)	–	–	3.5	VGE=15V, IC=10A	V
Input capacitance	Cies	–	1200	–	VGE=0V	pF
Output capacitance	Coes	–	250	–	VCE=10V	
Reverse transfer capacitance	Cres	–	80	–	f=1MHz	
Turn-on time	ton	–	–	1.2	VCC=600V IC=10A	µs
	tr	–	–	0.6	VGE=±15V	
Turn-off time	toff	–	–	1.5	RG=160 ohm	
	tf	–	–	0.5	(Half Bridge)	

1MB10D-120 / IGBT+FWD

Item	Symbol	Characteristics			Conditions	Unit
		Min.	Typ.	Max.		
Zero gate voltage collector current	ICES	–	–	1.0	VGE=0V, VCE=1200V	mA
Gate-Emitter leakage current	IGES	–	–	20	VCE=0V, VGE=±20V	µA
Gate-Emitter threshold voltage	VGE(th)	5.5	–	8.5	VCE=20V, IC=10mA	V
Collector-Emitter saturation voltage	VCE(sat)	–	–	3.5	VGE=15V, IC=10A	V
Input capacitance	Cies	–	1200	–	VGE=0V	pF
Output capacitance	Coes	–	250	–	VCE=10V	
Reverse transfer capacitance	Cres	–	80	–	f=1MHz	
Turn-on time	ton	–	–	1.2	VCC=600V, IC=10A	µs
	tr	–	–	0.6	VGE=±15V	
Turn-off time	toff	–	–	1.5	RG=160 ohm	
	tf	–	–	0.5	(Half Bridge)	
FWD forward on voltage	VF	–	–	3.0	IF=10A, VGE=0V	V
Reverse recovery time	trr	–	–	0.35	IF=10A, VGE=-10V, di/dt=100A/µs	µs

● Thermal resistance characteristics

1MB10-120 / IGBT

Item	Symbol	Characteristics			Conditions	Unit
		Min.	Typ.	Max.		
Thermal resistance	Rth(j-c)	–	–	0.92	IGBT	°C/W

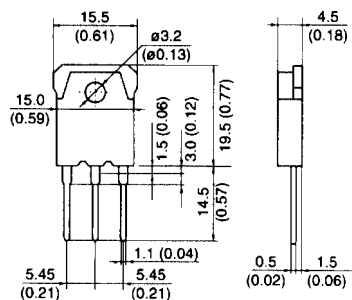
1MB10D-120 / IGBT+FWD

Item	Symbol	Characteristics			Conditions	Unit
		Min.	Typ.	Max.		
Thermal resistance	Rth(j-c)	–	–	0.92	IGBT	°C/W
	Rth(j-c)	–	–	1.47	FWD	°C/W

■ Outline drawings, mm

1MB10-120, 1MB10D-120

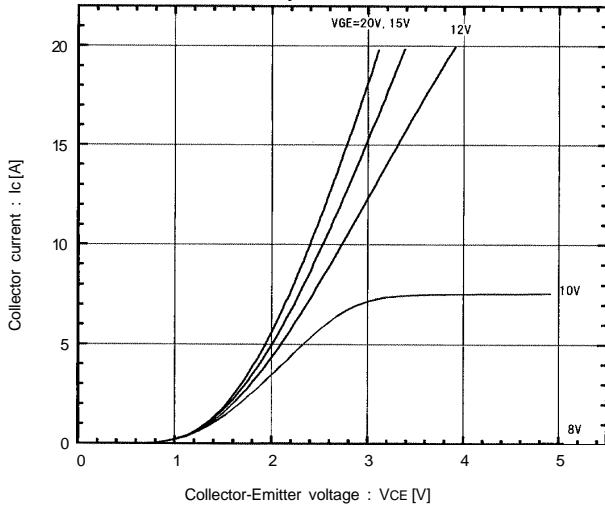
TO-3P



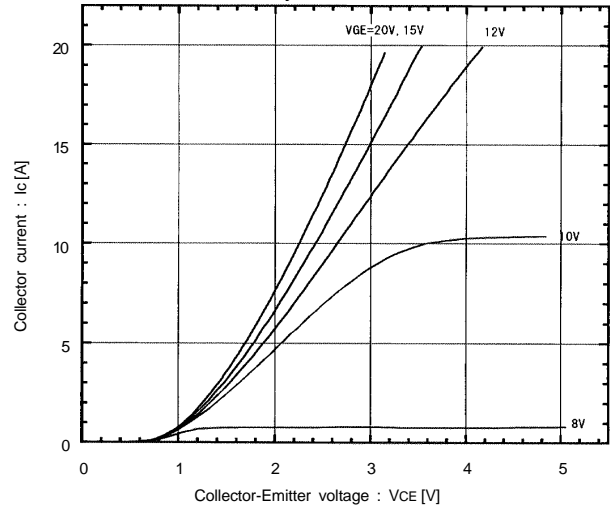
Characteristics

1MB10-120, 1MB10D-120

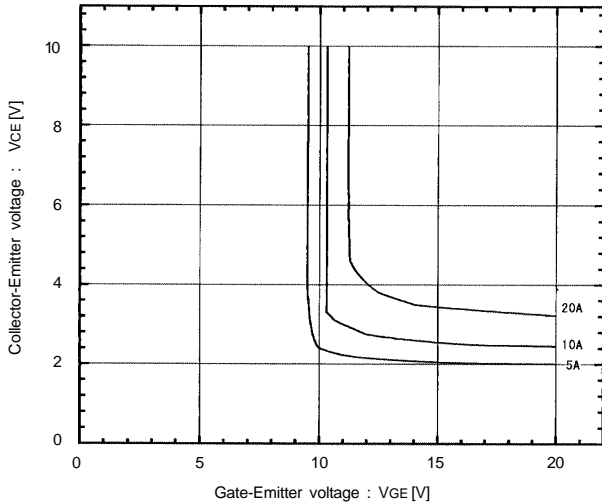
Collector current vs. Collector-Emitter voltage
T_j=25°C



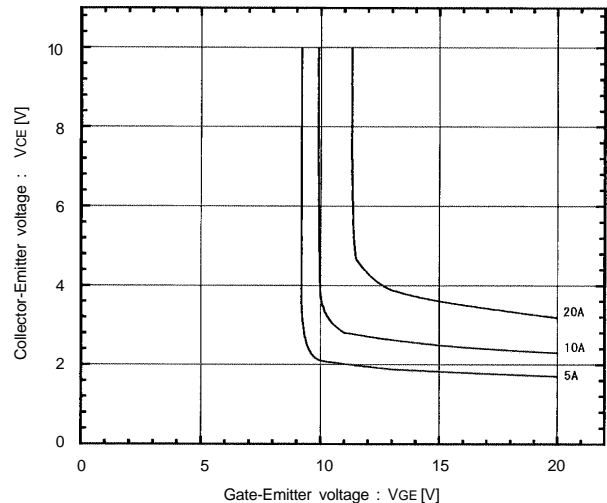
Collector current vs. Collector-Emitter voltage
T_j=125°C



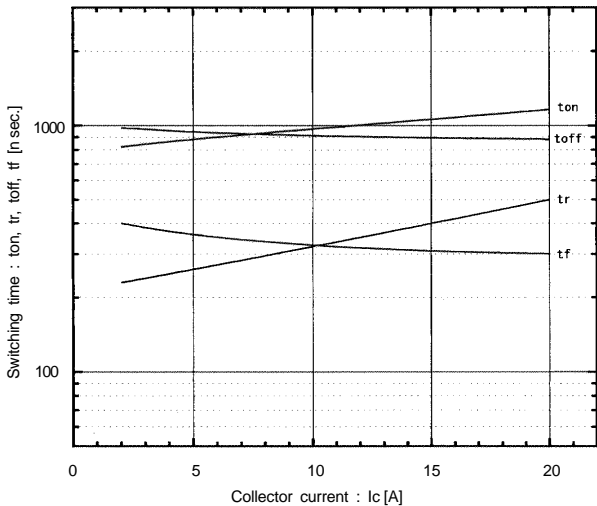
Collector-Emitter vs. Gate-Emitter voltage
T_j=25°C



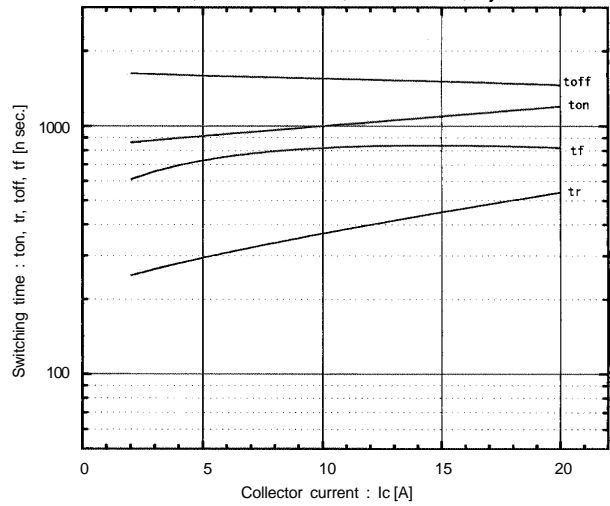
Collector-Emitter vs. Gate-Emitter voltage
T_j=125°C



Switching time vs. Collector current
V_{CC}=600V, R_G=160 ohm, V_{GE}=±15V, T_j=25°C

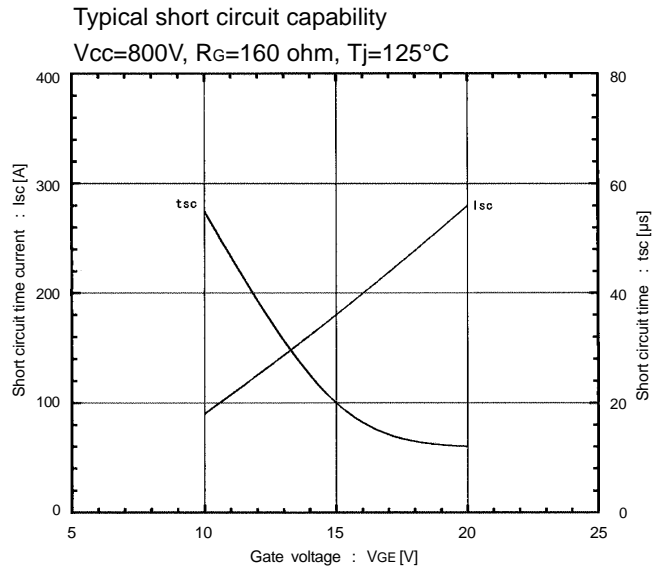
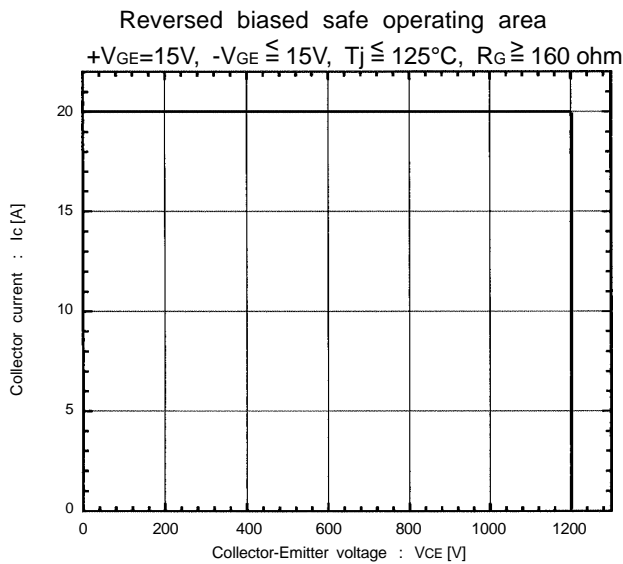
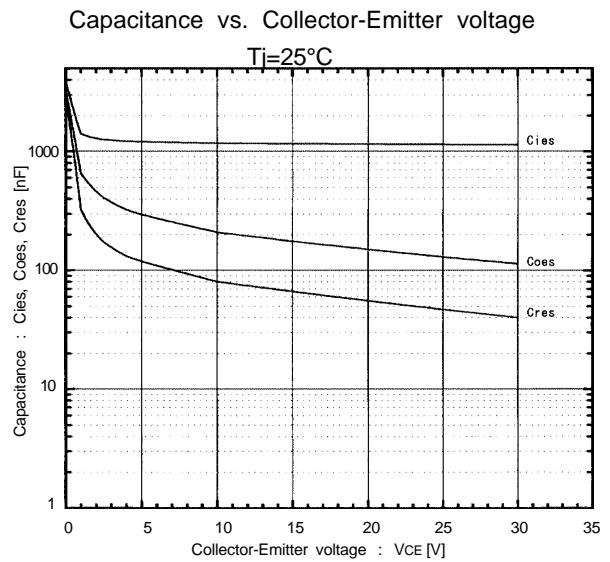
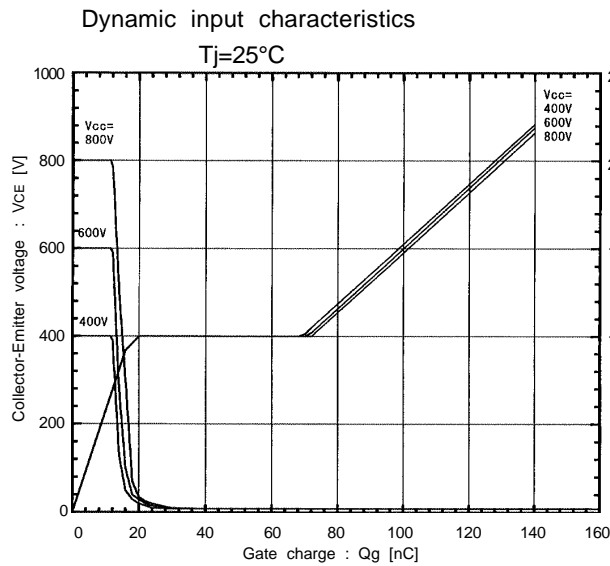
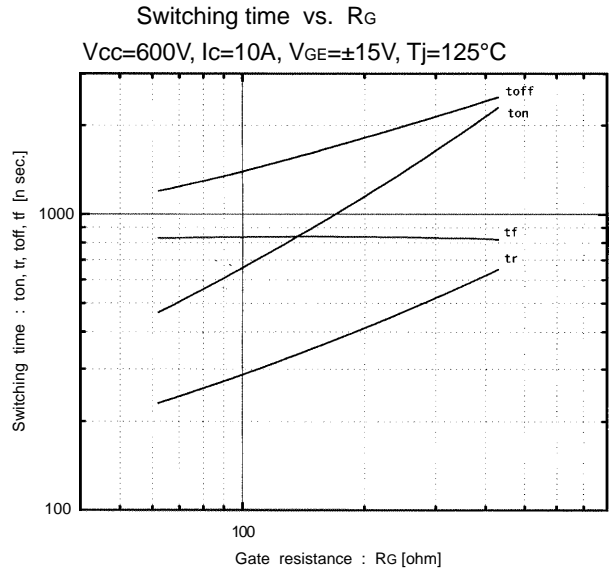
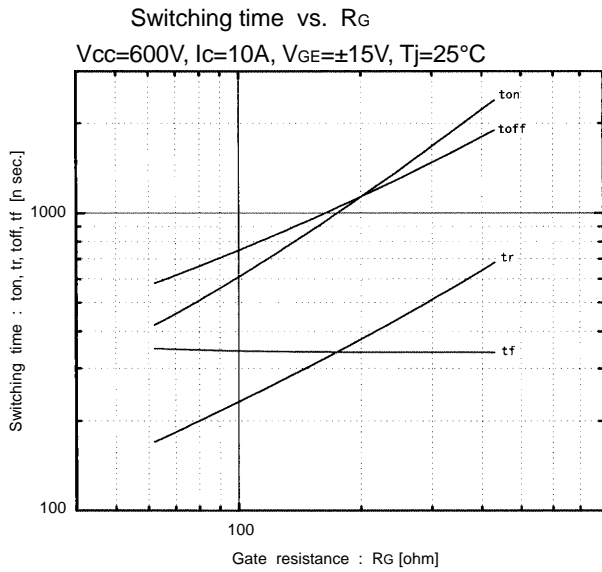


Switching time vs. Collector current
V_{CC}=600V, R_G=160 ohm, V_{GE}=±15V, T_j=125°C



Characteristics

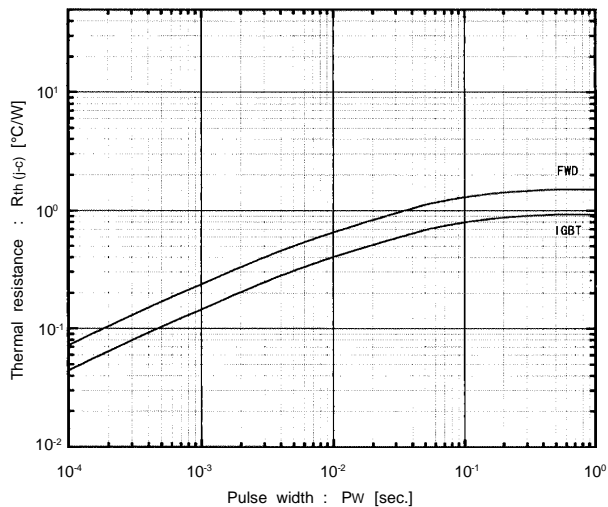
1MB10-120, 1MB10D-120



■ Characteristics

1MB10-120, 1MB10D-120

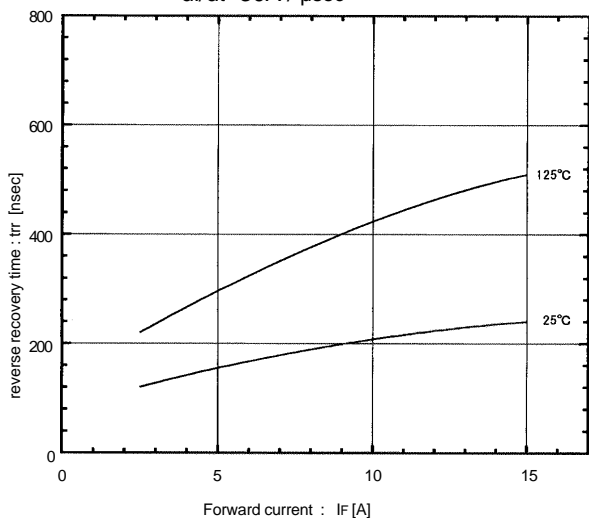
Transient thermal resistance



1MB10D-120

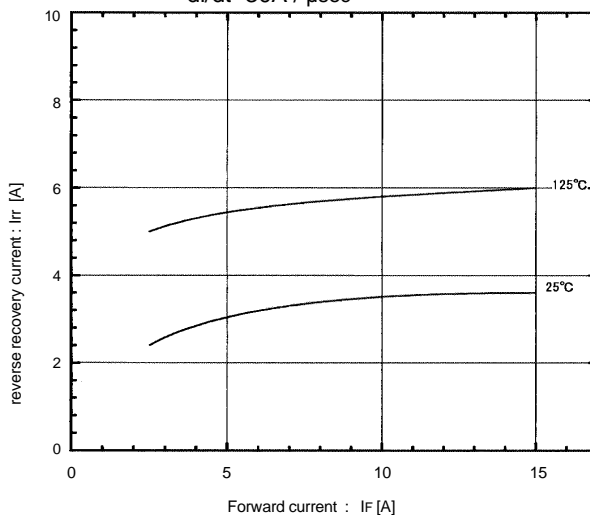
Reverse recovery time vs. Forward current

-di/dt=30A / μsec

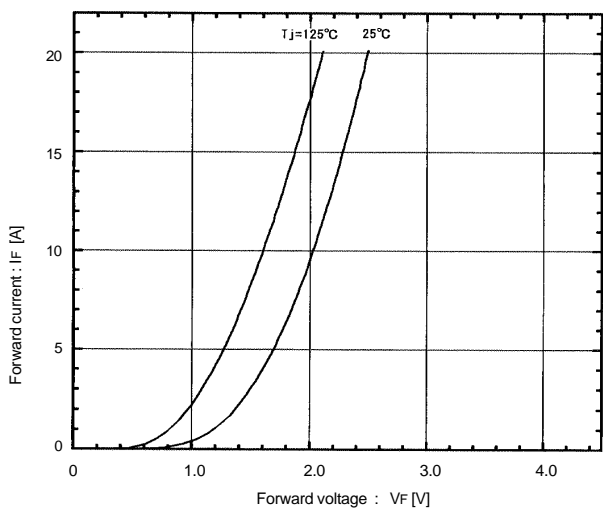


Reverse recovery current vs. Forward current

-di/dt=30A / μsec



Forward current vs. Forward voltage



Reverse recovery time characteristics vs. -di/dt

IF=10A, Tj=125°C

